

## N-Channel Power MOSFET

40V, 121A, 3.3mΩ

### FEATURES

- Low  $R_{DS(ON)}$  to minimize conductive losses
- Low gate charge for fast power switching
- 100% UIS and  $R_g$  tested.
- 175°C Operating Junction Temperature
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

### KEY PERFORMANCE PARAMETERS

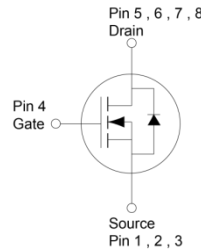
| PARAMETER          | VALUE          | UNIT |
|--------------------|----------------|------|
| $V_{DS}$           | 40             | V    |
| $R_{DS(on)}$ (max) | $V_{GS} = 10V$ | 3.3  |
| $Q_g$              | 77             | nC   |

### APPLICATIONS

- BLDC Motor Control
- Battery Power Management
- DC-DC converter
- Secondary Synchronous Rectification



PDFN56



**Note:** MSL 1 (Moisture Sensitivity Level) per J-STD-020

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| PARAMETER                                        | SYMBOL         | LIMIT                     | UNIT             |
|--------------------------------------------------|----------------|---------------------------|------------------|
| Drain-Source Voltage                             | $V_{DS}$       | 40                        | V                |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$                  | V                |
| Continuous Drain Current (Note 1)                | $I_D$          | $T_C = 25^\circ\text{C}$  | A                |
|                                                  |                | $T_A = 25^\circ\text{C}$  |                  |
| Pulsed Drain Current                             | $I_{DM}$       | 484                       | A                |
| Single Pulse Avalanche Current (Note 2)          | $I_{AS}$       | 36                        | A                |
| Single Pulse Avalanche Energy (Note 2)           | $E_{AS}$       | 194                       | mJ               |
| Total Power Dissipation                          | $P_D$          | $T_C = 25^\circ\text{C}$  | W                |
|                                                  |                | $T_C = 125^\circ\text{C}$ |                  |
| Total Power Dissipation                          | $P_D$          | $T_A = 25^\circ\text{C}$  | W                |
|                                                  |                | $T_A = 125^\circ\text{C}$ |                  |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | - 55 to +175              | $^\circ\text{C}$ |

### THERMAL PERFORMANCE

| PARAMETER                              | SYMBOL          | LIMIT | UNIT               |
|----------------------------------------|-----------------|-------|--------------------|
| Junction to Case Thermal Resistance    | $R_{\theta JC}$ | 1.4   | $^\circ\text{C/W}$ |
| Junction to Ambient Thermal Resistance | $R_{\theta JA}$ | 48    | $^\circ\text{C/W}$ |

**Thermal Performance Note:**  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\theta JA}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design. The  $R_{\theta JA}$  limit presented here is based on mounting on a 1 in<sup>2</sup> pad of 2 oz copper.

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| PARAMETER                                    | CONDITIONS                                                                                 | SYMBOL              | MIN | TYP  | MAX  | UNIT |
|----------------------------------------------|--------------------------------------------------------------------------------------------|---------------------|-----|------|------|------|
| Static                                       |                                                                                            |                     |     |      |      |      |
| Drain-Source Breakdown Voltage               | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                                               | BV <sub>DSS</sub>   | 40  | --   | --   | V    |
| Gate Threshold Voltage                       | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA                                 | V <sub>GS(TH)</sub> | 2   | 2.9  | 4    | V    |
| Gate-Source Leakage Current                  | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V                                               | I <sub>GSS</sub>    | --  | --   | ±100 | nA   |
| Drain-Source Leakage Current                 | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 40V                                                | I <sub>DSS</sub>    | --  | --   | 1    | μA   |
|                                              | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 40V<br>T <sub>J</sub> = 125°C                      |                     | --  | --   | 100  |      |
|                                              |                                                                                            |                     |     |      |      |      |
| Drain-Source On-State Resistance<br>(Note 3) | V <sub>GS</sub> = 10V, I <sub>D</sub> = 21A                                                | R <sub>DS(on)</sub> | --  | 2.4  | 3.3  | mΩ   |
| Forward Transconductance (Note 3)            | V <sub>DS</sub> = 10V, I <sub>D</sub> = 21A                                                | g <sub>fs</sub>     | --  | 64   | --   | S    |
| Dynamic (Note 4)                             |                                                                                            |                     |     |      |      |      |
| Total Gate Charge                            | V <sub>GS</sub> = 10V, V <sub>DS</sub> = 20V,<br>I <sub>D</sub> = 21A                      | Q <sub>g</sub>      | --  | 77   | -    | nC   |
| Gate-Source Charge                           |                                                                                            | Q <sub>gs</sub>     | --  | 23   | --   |      |
| Gate-Drain Charge                            |                                                                                            | Q <sub>gd</sub>     | --  | 19   | --   |      |
| Input Capacitance                            | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 20V<br>f = 1.0MHz                                  | C <sub>iss</sub>    | --  | 5022 | --   | pF   |
| Output Capacitance                           |                                                                                            | C <sub>oss</sub>    | --  | 484  | --   |      |
| Reverse Transfer Capacitance                 |                                                                                            | C <sub>rss</sub>    | --  | 250  | --   |      |
| Gate Resistance                              | f = 1.0MHz                                                                                 | R <sub>g</sub>      | 0.5 | 1.5  | 3    | Ω    |
| Switching (Note 4)                           |                                                                                            |                     |     |      |      |      |
| Turn-On Delay Time                           | V <sub>GS</sub> = 10V, V <sub>DS</sub> = 20V,<br>I <sub>D</sub> = 21A, R <sub>G</sub> = 2Ω | t <sub>d(on)</sub>  | --  | 7    | --   | ns   |
| Turn-On Rise Time                            |                                                                                            | t <sub>r</sub>      | --  | 22   | --   |      |
| Turn-Off Delay Time                          |                                                                                            | t <sub>d(off)</sub> | --  | 35   | --   |      |
| Turn-Off Fall Time                           |                                                                                            | t <sub>f</sub>      | --  | 17   | --   |      |
| Source-Drain Diode                           |                                                                                            |                     |     |      |      |      |
| Forward Voltage (Note 3)                     | V <sub>GS</sub> = 0V, I <sub>S</sub> = 21A                                                 | V <sub>SD</sub>     | --  | --   | 1    | V    |
| Reverse Recovery Time                        | I <sub>S</sub> = 21A ,                                                                     | t <sub>rr</sub>     | --  | 26   | --   | ns   |
| Reverse Recovery Charge                      | di/dt = 100A/μs                                                                            | Q <sub>rr</sub>     | --  | 19   | --   | nC   |

**Notes:**

- Silicon limited current only.
- $L = 0.3\text{mH}$ ,  $V_{GS} = 10V$ ,  $V_{DD} = 25V$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 36A$ , Starting  $T_J = 25^\circ\text{C}$
- Pulse test: Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- Switching time is essentially independent of operating temperature.

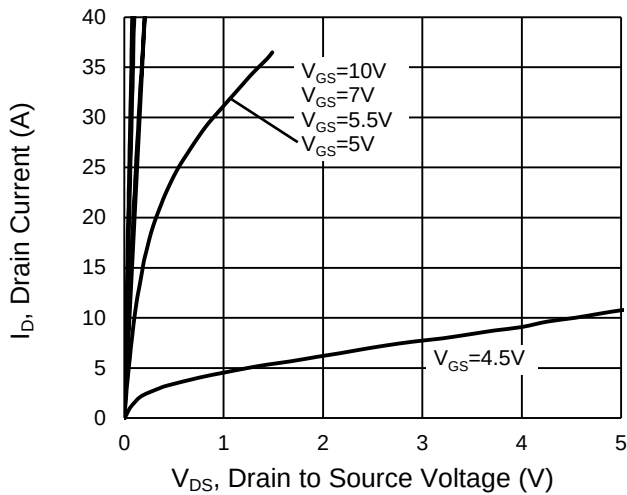
**ORDERING INFORMATION**

| PART NO.         | PACKAGE | PACKING             |
|------------------|---------|---------------------|
| TSM033NB04CR RLG | PDFN56  | 2,500pcs / 13" Reel |

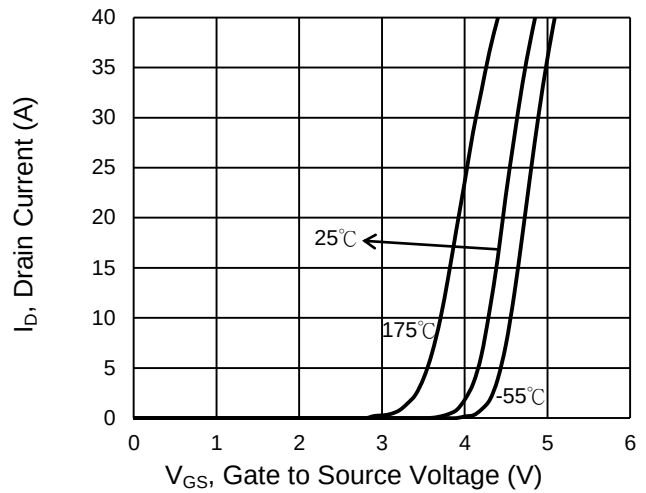
## CHARACTERISTICS CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

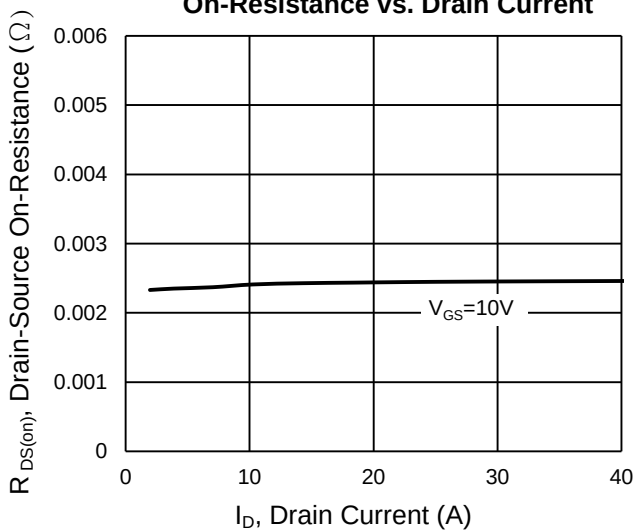
**Output Characteristics**



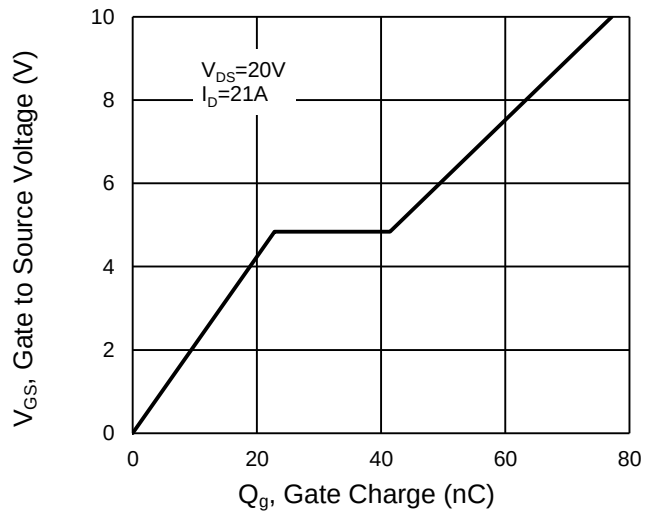
**Transfer Characteristics**



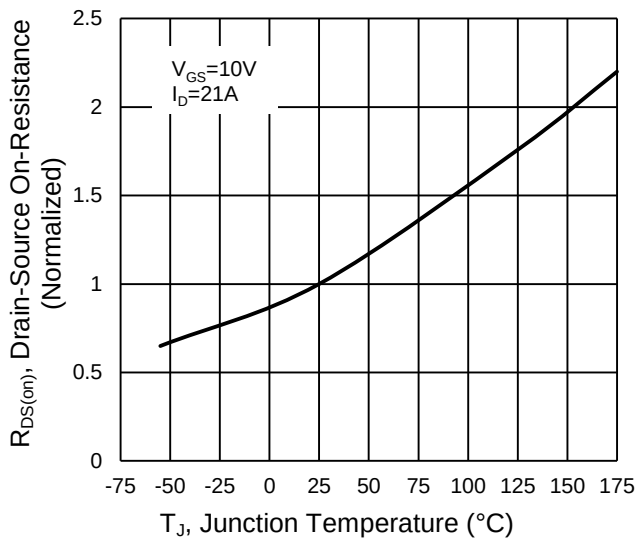
**On-Resistance vs. Drain Current**



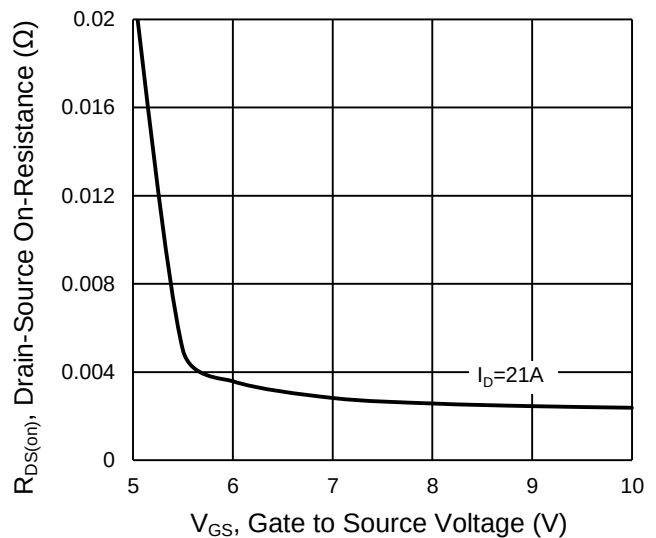
**Gate-Source Voltage vs. Gate Charge**



**On-Resistance vs. Junction Temperature**

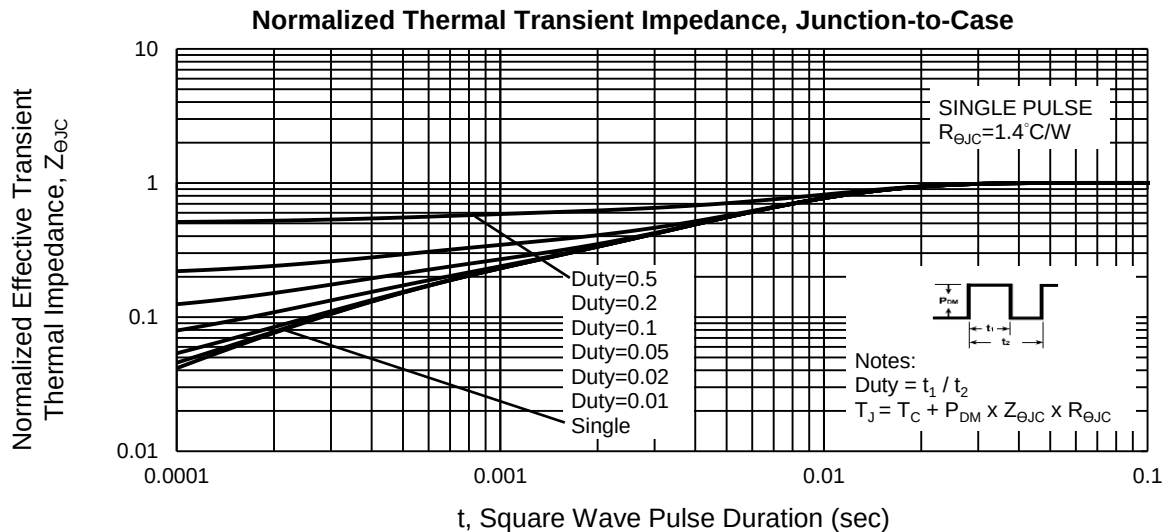
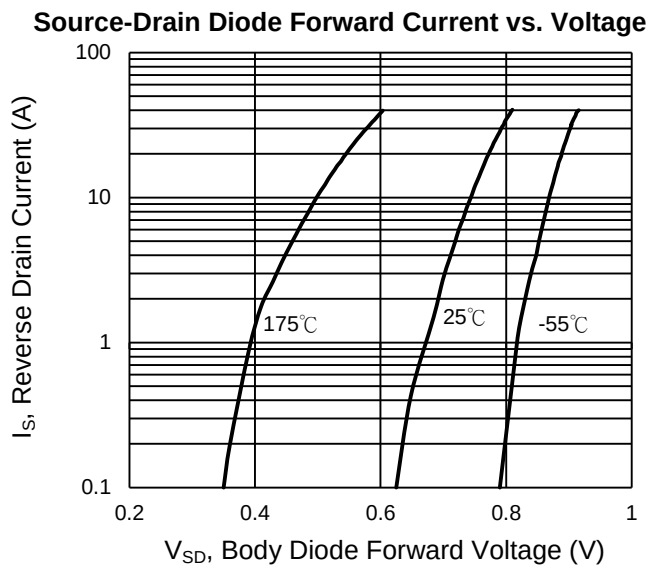
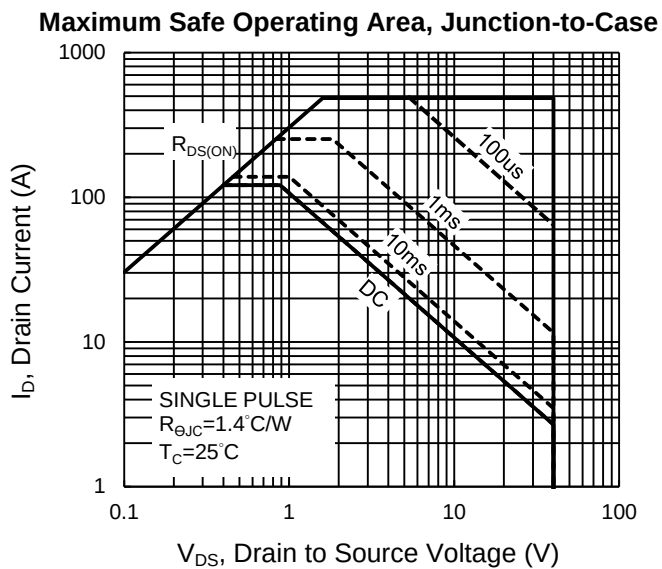
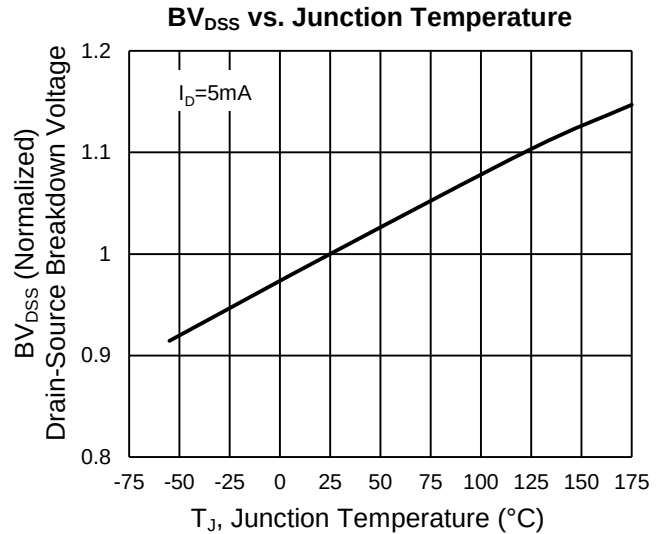
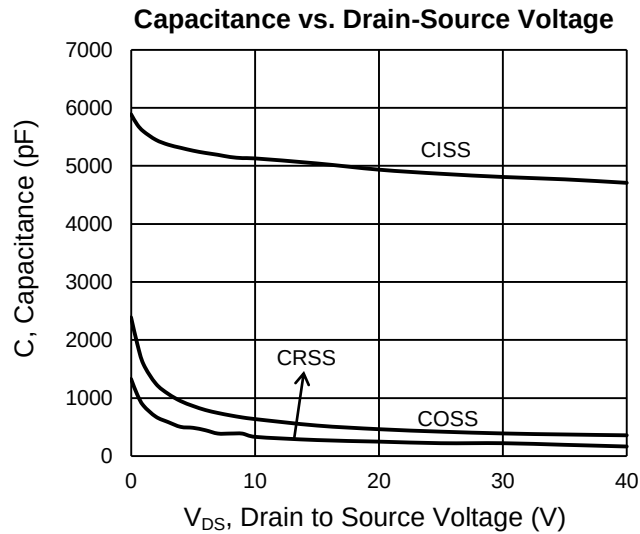


**On-Resistance vs. Gate-Source Voltage**



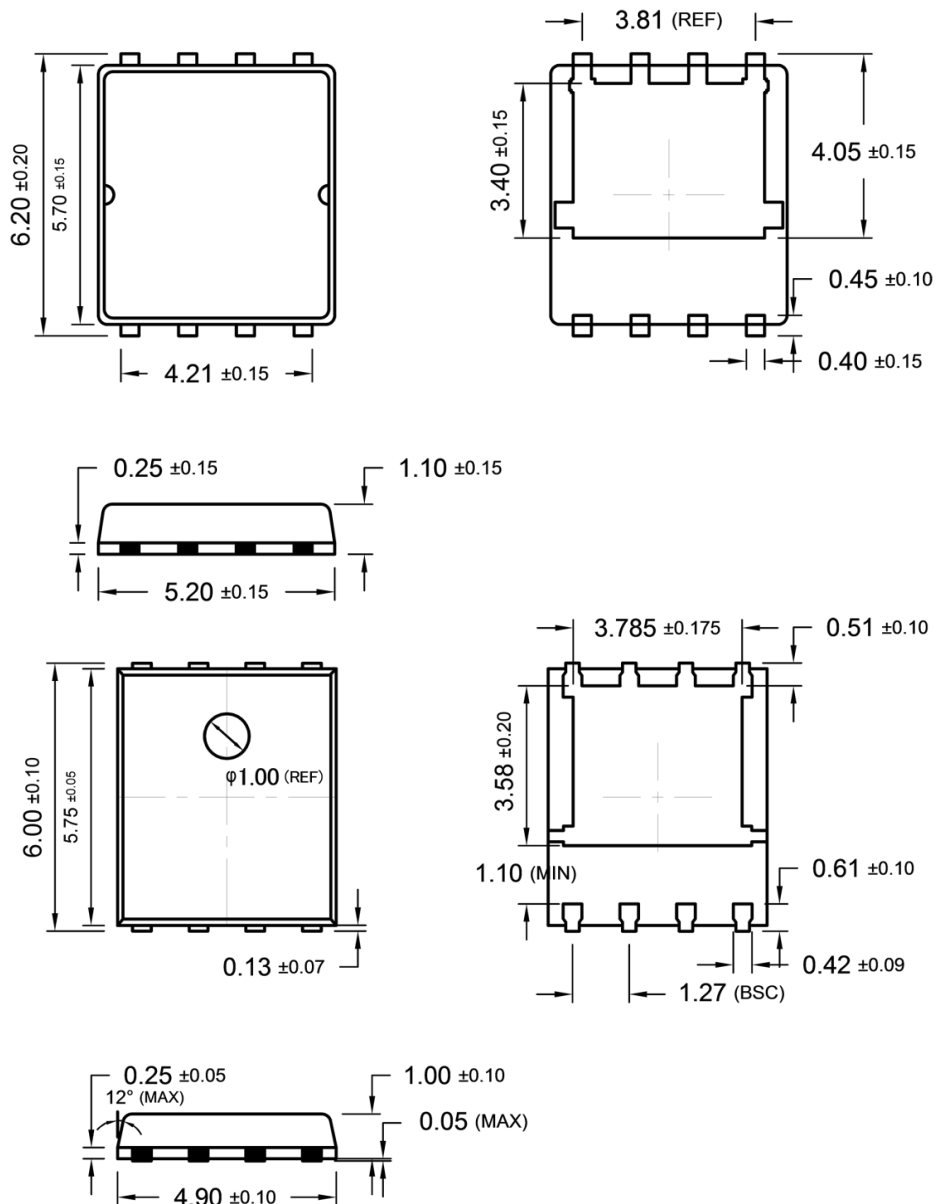
## CHARACTERISTICS CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

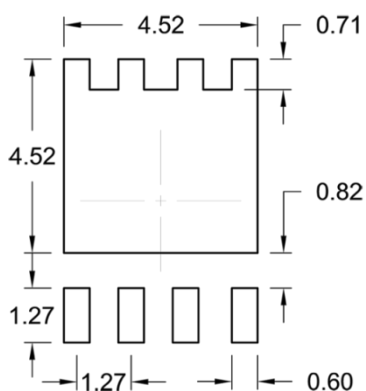


**PACKAGE OUTLINE DIMENSIONS** (Unit: Millimeters)

**PDFN56**



**SUGGESTED PAD LAYOUT** (Unit: Millimeters)



**MARKING DIAGRAM**



**G** = Halogen Free  
**Y** = Year Code  
**WW** = Week Code (01~52)  
**F** = Factory Code

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